Technical Data Sheet

0603 Package Chip LED (0.8 mm Height)

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within ROHS complaint version.

Descriptions

- The 19-21 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.
- Indoor signboard use.

Device Selection Guide

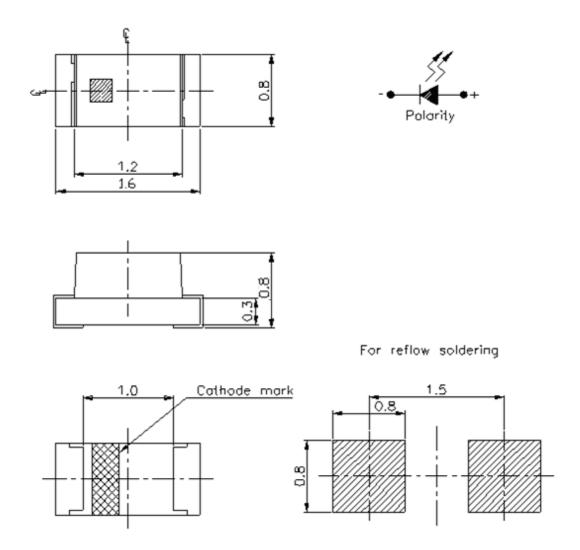
Part No.	Chip		Resin Color	
	Material	Emitted Color		
19-21SYGC/S530-E2/TR8	AlGaInP	Brilliant Yellow Green	Water Clear	



19-21SYGC/S530-E2/TR8



Package Outline Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

19-21SYGC/S530-E2/TR8

Absolute Maximum	Ratings (Ta=25°C)					
Parameter		Sym	ibol	Rating		Unit	
Reverse Voltag	ge	V	R	5		V	
Forward Curre	nt	I _F	7	25		mA	
Peak Forward Current		I _{FP}		60		mA	
(Duty 1/10 @1K	(Duty 1/10 @1KHz)						
Power Dissipation		P _d		60		mW	
Electrostatic Discharge(HBM)		ESD		2000		V	
Operating Temperature		Topr		-40 ~ +85		°C	
Storage Tempera	ture	Tstg		-40 ~ +90 °C			
Soldering Temperature		Tsol		Reflow Soldering : 260 $^{\circ}$ C for 10 sec. Hand Soldering : 350 $^{\circ}$ C for 3 sec.			
Electro-Optical Characteristics (Ta=25°C)							
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	

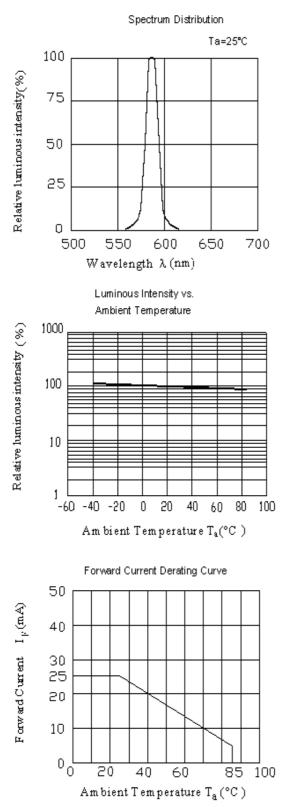
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Luminous Intensity	I_v	16	21		mcd		
Viewing Angle	$2 \theta 1/2$		100		deg		
Peak Wavelength	λp		575		nm		
Dominant Wavelength	λd		573		nm	IF=20 mA	
Spectrum Radiation Bandwidth	$ riangle \lambda$		20		nm		
Forward Voltage	$V_{\rm F}$	1.7	2.0	2.4	V]	
Reverse Current	I _R			10	μ A	V _R =5V	

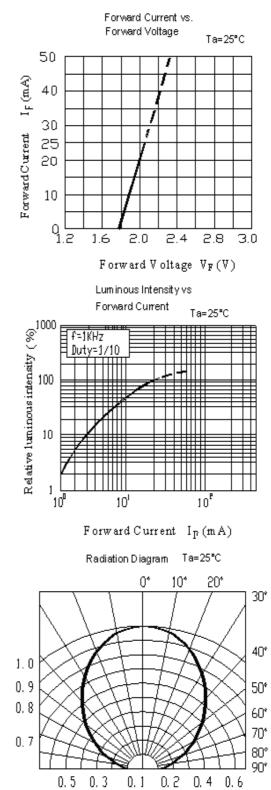
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19-21SYGC/S530-E2/TR8

Typical Electro-Optical Characteristics Curves

EVERLIGHT





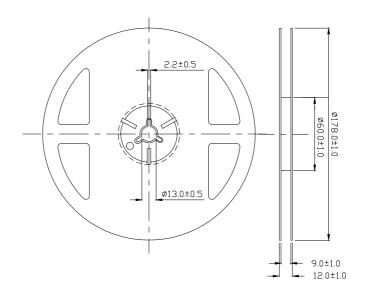
Everlight Electronics Co., Ltd. Device No: SZDSE-191http://www.everlight.com Prepared date: 8-Apr -2009 Rev 2 Page: 4 of 9 Prepared by: Wuhongmei

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Label explanation

- **CAT: Luminous Intensity Rank**
- HUE: Dom. Wavelength Rank
- **REF: Forward Voltage Rank**

Reel Dimensions

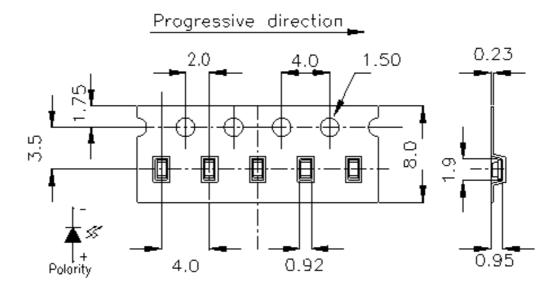


Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

http://www.everlight.com Prepared date: 8-Apr -2009

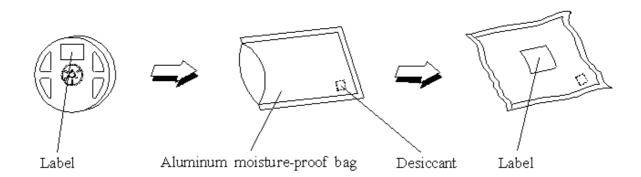
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Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below. Confidence level : 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100°C 5min $\int 10 \sec$ L: -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°℃	1000 Hrs.	22 PCS.	0/1
б	DC Operating Life	IF = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/ 85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

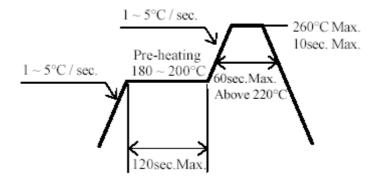
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30° C or less and 60% RH or less.

If unused LEDs remain, it should be stored in moisture proof packages.

- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



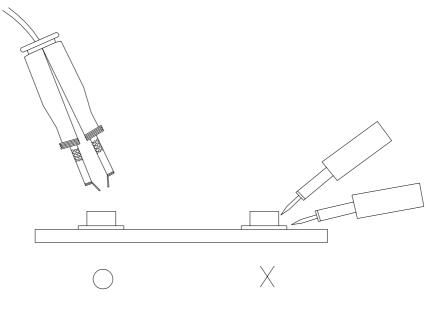
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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